

Silicon Carbide (SiC) Diode – EliteSiC, TO247-2, 50 A, 1200 V SiC Merged PiN-Schottky (MPS) Diode

UJ3D1250K2

Description

onsemi offers the 3rd generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175 °C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.

Features

- Maximum Operating Temperature of 175 °C
- Easy Paralleling
- Extremely Fast Switching not Dependent on Temperature
- No Reverse or Forward Recovery
- Enhanced Surge Current Capability, MPS Structure
- 100% UIS Tested
- This Device is Halogen Free and RoHS Compliant with Exemption 7a, Pb-Free 2LI (on second level interconnection)

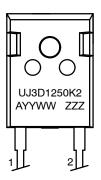
Typical Applications

- Power Converters
- Industrial Motor Drives
- Switch Mode Power Supplies
- Power Factor Correction Modules



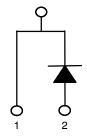
TO247-2 CASE 340CY

MARKING DIAGRAM



UJ3D1250K2 = Specific Device Code A = Assembly Location

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

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UJ3D1250K2

MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Value	Unit	
DC Blocking Voltage	V_{R}		1200	٧	
Repetitive Peak Reverse Voltage, $T_J = 25$ °C	V_{RRM}		1200	٧	
Surge Peak Reverse Voltage	V_{RSM}		1200	V	
Maximum DC Forward Current	I _F	T _C = 112 °C	50	А	
Non-repetitive Forward Surge Current Sine Halfwave	I _{FSM}	T_C = 25 °C, t_p = 10 ms	275	А	
Repetitive Forward Surge Current Sine Halfwave, D = 0.1	I _{FRM}	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	163.5	А	
		$T_C = 110 ^{\circ}\text{C}, t_p = 10 \text{ms}$	99.6		
Non-repetitive Peak Forward Current	I _{F, max}	$T_C = 25 {}^{\circ}\text{C}, t_p = 10 \mu\text{s}$	2400	А	
		$T_C = 110 {}^{\circ}\text{C}, t_p = 10 \mu\text{s}$	2400		
i ² t Value	∫i²dt	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	378	A ² s	
Power Dissipation	P _{tot}	T _C = 25 °C	319	W	
		T _C = 112 °C	134		
Maximum Junction Temperature	T _{J, max}		175	°C	
Operating and Storage Temperature	T _J , T _{STG}		-55 to 175	°C	
Soldering Temperatures, Wavesoldering only Allowed at Leads	T _{sold}	1.6 mm from case for 10 s	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		-	0.36	0.47	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = +25$ °C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _F	I _F = 50 A, T _J = 25 °C	-	1.5	1.7	٧
		I _F = 50 A, T _J = 150 °C	-	1.95	2.4	1
		I _F = 50 A, T _J = 175 °C	-	2.2	2.7	1
Reverse Current	I _R	V _R = 1200 V, T _J = 25 °C	-	54	400	μΑ
		V _R = 1200 V, T _J = 175 °C	-	900	-	
Total Capacitive Charge (Note 1)	$Q_{\mathbb{C}}$	V _R = 800 V	-	240	-	nC
Total Capacitance	С	V _R = 1 V, f = 1 MHz	-	2340	-	pF
		V _R = 400 V, f = 1 MHz	-	224	-	
		V _R = 800 V, f = 1 MHz	-	198	-	1
Capacitance Stored Energy	E _C	V _R = 800 V	-	72	-	μJ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Q_C is independent on T_J , di_F/dt , and I_F as shown in the application note <u>AND90316/D</u>

UJ3D1250K2

TYPICAL PERFORMANCE DIAGRAMS

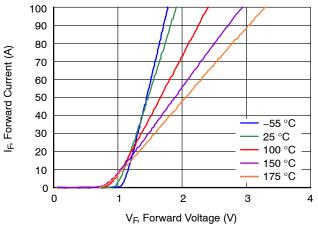


Figure 1. Typical Forward Characteristics

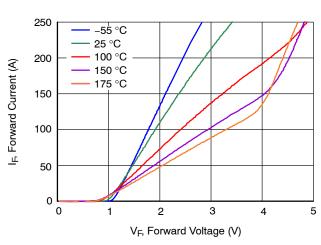


Figure 2. Typical Forward Characteristics in Surge Current

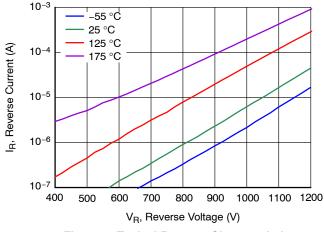


Figure 3. Typical Reverse Characteristics

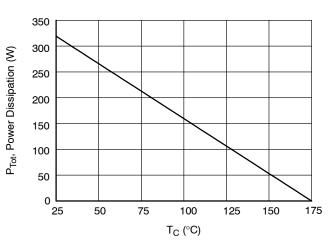


Figure 4. Power Dissipation

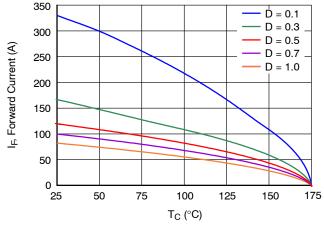


Figure 5. Diode Forward Current

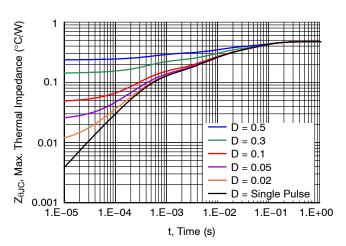


Figure 6. Maximum Transient Thermal Impedance

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TYPICAL PERFORMANCE DIAGRAMS (continued)

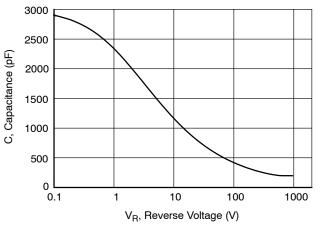


Figure 7. Capacitance vs. Reverse Voltage at 1 MHz

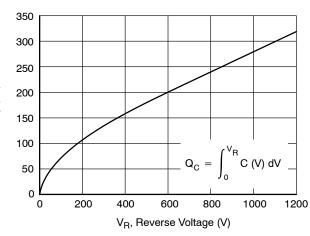


Figure 8. Typical Capacitive Charge vs. Reverse Voltage

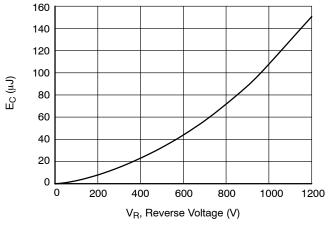
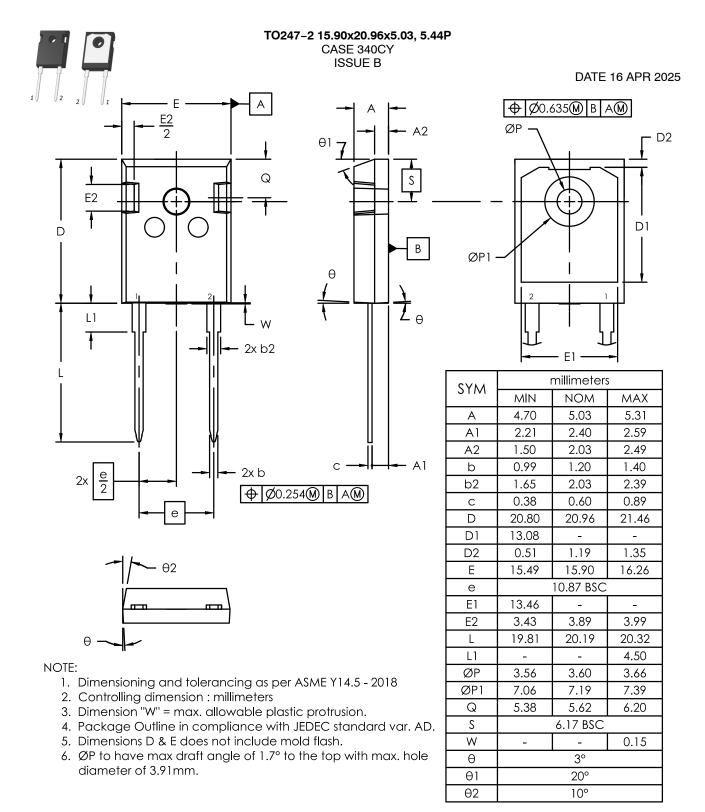


Figure 9. Typical Capacitance Stored Energy vs. Reverse Voltage

ORDERING INFORMATION

Part Number	Marking	Package	Shipping
UJ3D1250K2	UJ3D1250K2	TO247-2 (Pb-Free, Halogen Free)	600 Units / Tube





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DESCRIPTION:	TO247-2 15.90x20.96x5.03, 5.44P		PAGE 1 OF 1	

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